

Product Summary

$V_{(BR)CES}$	$V_{CE(SAT)MAX}$	$I_C(100^{\circ}C)$
650V	1.95V@15V	40A

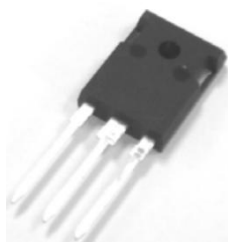
Feature

- High speed smooth switching device for hard & soft switching
- Maximum junction temperature 175°C
- Positive temperature coefficient
- High ruggedness, temperature stable

Application

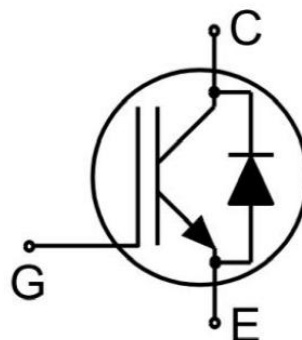
- Solar converters
- Uninterruptible power supplies
- Welding converters
- Mid to high range switching frequency converters

Package

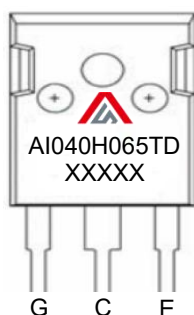


TO-247AB

Circuit diagram



Marking



Absolute maximum ratings (T_C=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CES}	650	V
Continuous Gate- Emitter Voltage	V _{GE}	±20	V
Transient Gate-Emitter Voltage (tp≤10us,D<0.010)	V _{GE}	±30	V
Collector Current, limited by T _{Jmax}	I _C	80	A
Collector Current, limited by T _{Jmax} (T _C =100°C)	I _C (100°C)	40	A
Pulsed Collector Current, V _{GE} =15V, tp limited by T _{Jmax}	I _{CM}	80	A
Diode Continuous Forward Current	I _F	80	A
Diode Continuous Forward Current (T _C =100°C)	I _F (100°C)	40	A
Diode Pulsed Current, tp limited by T _{Jmax}	I _{Fpuls}	80	A
Turn off Safe Operating Area V _{CE} ≤650V,T _J ≤150°C	-	80	A
Power Dissipation (T _J =175°C)	P _D	214	W
Thermal Resistance, Junction to case for Diode	R _{θJC}	1.05	°C/W
Thermal Resistance, Junction to case for IGBT	R _{θJC}	0.70	°C/W
Thermal Resistance, Junction - Ambient	R _{θJA}	40	°C/W
Operating junction temperature range	T _J	-40 ~ +175	°C
Storage Temperature Range	T _{STG}	-55 ~ +175	°C

Electrical characteristics of the IGBT (T_J=25°C unless otherwise noted)

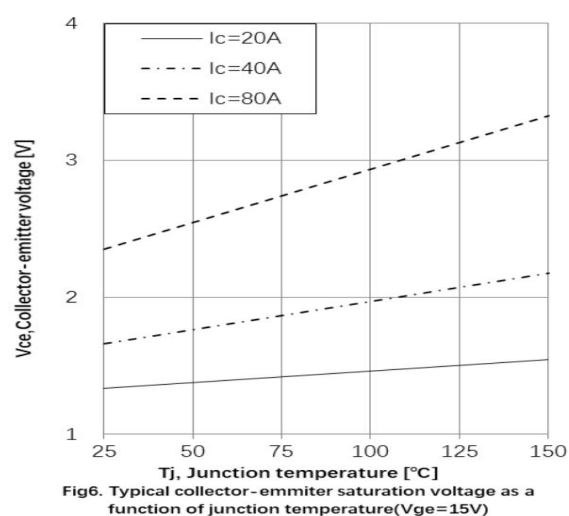
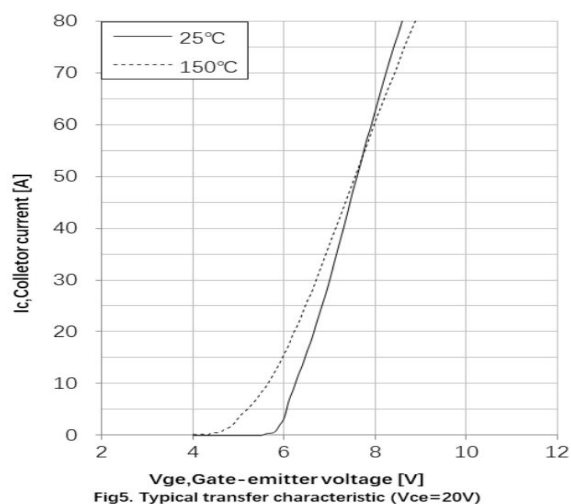
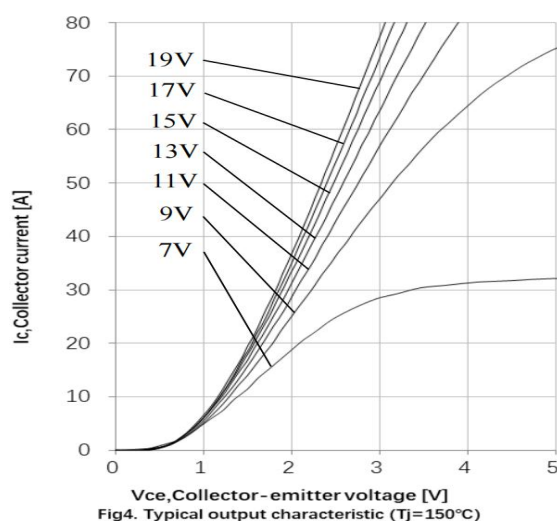
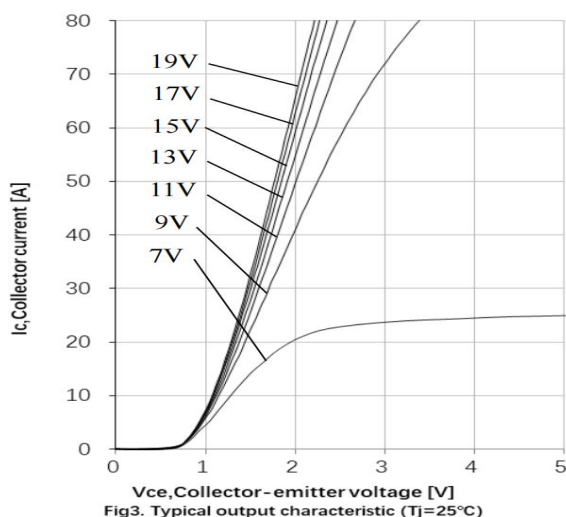
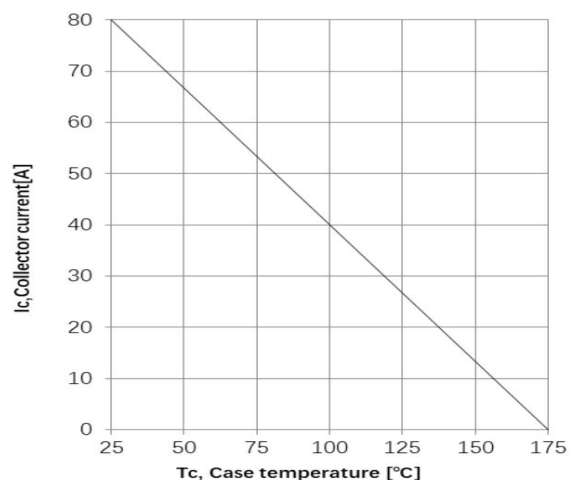
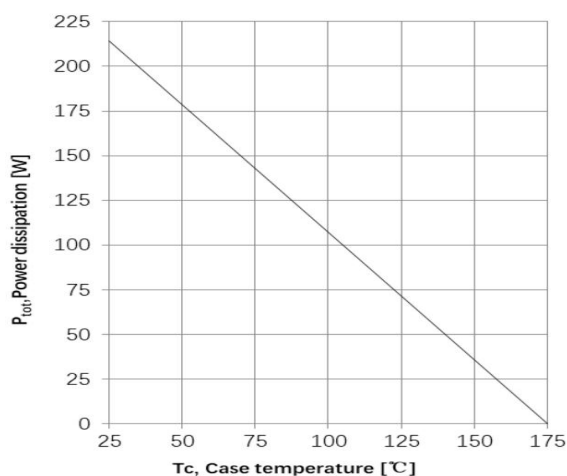
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Collector-Emitter Breakdown Voltage	V _{(BR)CES}	V _{GE} =0V, I _C =250μA	650			V
Collector-Emitter Leakage Current	I _{CES}	V _{GE} =0V,V _{CE} =650V			0.25	mA
		V _{GE} =0V,V _{CE} =650V,T _J =150°C			4.00	
Gate to Emitter Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V			100	nA
Gate Threshold Voltage	V _{GE(th)}	V _{CE} =V _{GE} ,I _C =0.25mA	3.5	4.5	5.5	V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} =15V,I _C =40A		1.65	1.95	V
		V _{GE} =15V,I _C =40A,T _J =125°C		2.10		
		V _{GE} =15V,I _C =40A,T _J =150°C		2.20		
Dynamic characteristics						
Input Capacitance	C _{ies}	V _{CE} =25V,V _{GE} =0V, f =1MHz		2.83		nF
Reverse Transfer Capacitance	C _{res}			0.02		
Total Gate Charge	Q _g	V _{CC} =520V,V _{GE} =15V,I _C =40A		0.10		μC
Turn-on delay time	t _{d(on)}	V _{CC} =400V,V _{GE} =-5V~15V, I _C =40A,R _G =20Ω,		52		nS
Turn-on rise time	t _r			68		
Turn-off delay time	t _{d(off)}			149		
Turn-off fall time	t _f			39		
Turn-On Switching Loss	E _{on}			1.94		mJ
Turn-Off Switching Loss	E _{off}			0.51		
Turn-on delay time	t _{d(on)}	V _{CC} =400V,V _{GE} =-5V~15V, I _C =40A,R _G =20Ω, T _J =125°C		50		nS
Turn-on rise time	t _r			68		
Turn-off delay time	t _{d(off)}			156		
Turn-off fall time	t _f			38		
Turn-On Switching Loss	E _{on}			2.03		mJ
Turn-Off Switching Loss	E _{off}			0.55		

Turn-on delay time	$t_{d(on)}$	$V_{CC}=400V, V_{GE}=-5V \sim 15V,$ $I_C=40A, R_G=20\Omega,$ $T_J=150^\circ C$		49		nS
Turn-on rise time	t_r			69		
Turn-off delay time	$t_{d(off)}$			161		
Turn-off fall time	t_f			39		
Turn-On Switching Loss	E_{on}			2.08		mJ
Turn-Off Switching Loss	E_{off}			0.56		

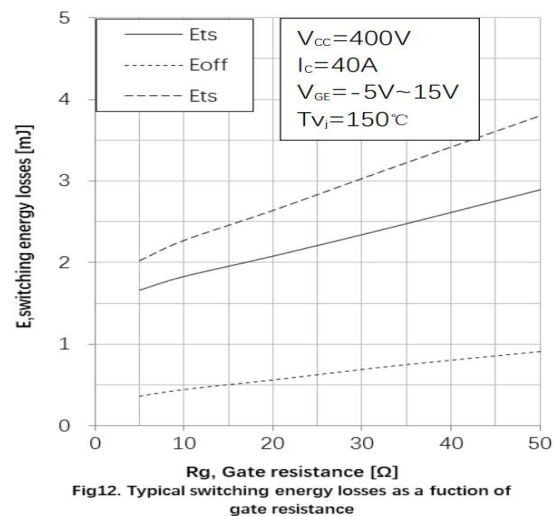
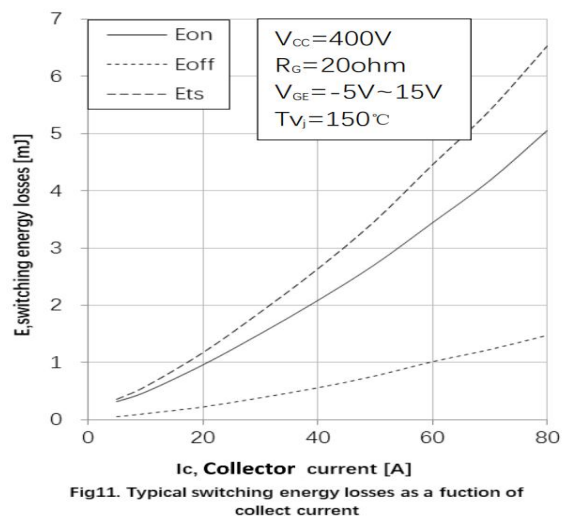
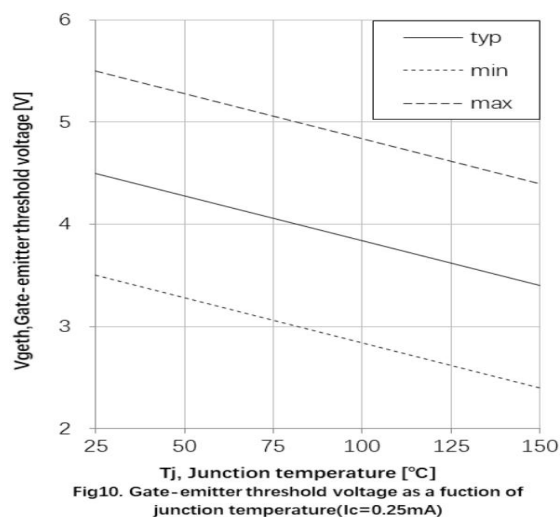
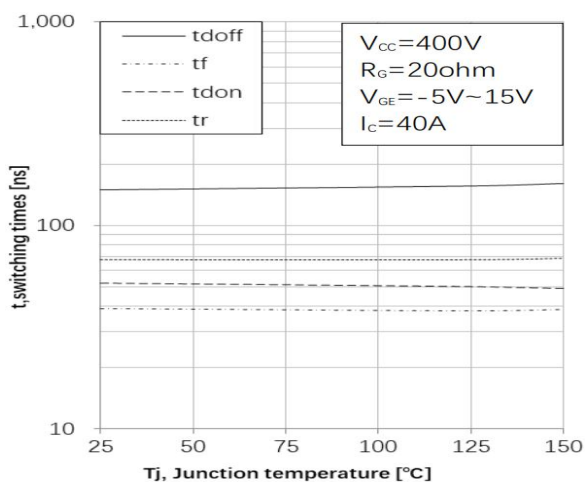
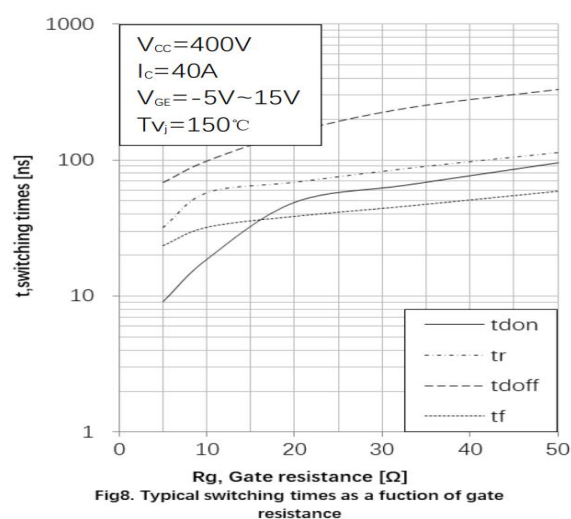
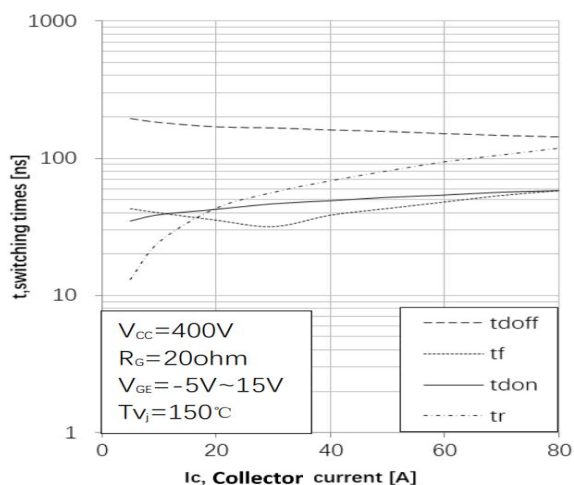
Electrical characteristics of the Diode ($T_J=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Diode Forward Voltage	V_F	$I_F=40A$		1.50	1.90	V
		$I_F=40A, T_J=125^\circ C$		1.40		
		$I_F=40A, T_J=150^\circ C$		1.35		
Reverse Recovery Current	I_{rr}	$V_R=400V, I_F=40A,$ $-di/dt=480A/\mu s$		34		A
Reverse Recovery Charge	Q_{rr}			3.22		μC
Reverse Recovery Time	t_{rr}			161		nS
Reverse recovery energy	E_{rec}			0.78		mJ
Reverse Recovery Current	I_{rr}	$V_R=400V, I_F=40A,$ $-di/dt=480A/\mu s,$ $T_J=125^\circ C$		37		A
Reverse Recovery Charge	Q_{rr}			4.32		μC
Reverse Recovery Time	t_{rr}			203		nS
Reverse recovery energy	E_{rec}			1.11		mJ
Reverse Recovery Current	I_{rr}	$V_R=400V, I_F=40A,$ $-di/dt=480A/\mu s,$ $T_J=150^\circ C$		38		A
Reverse Recovery Charge	Q_{rr}			4.87		μC
Reverse Recovery Time	t_{rr}			224		nS
Reverse recovery energy	E_{rec}			1.28		mJ

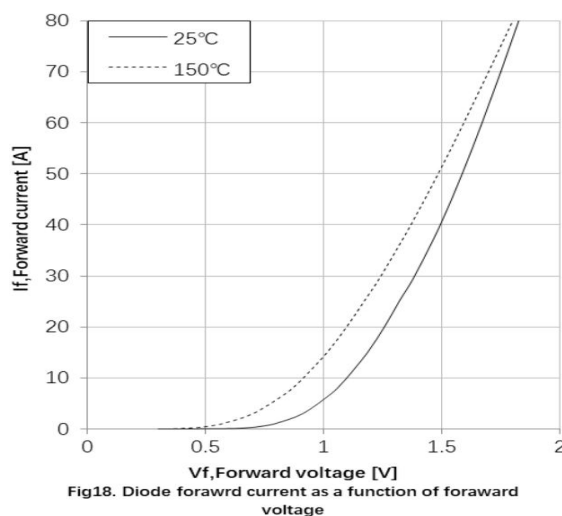
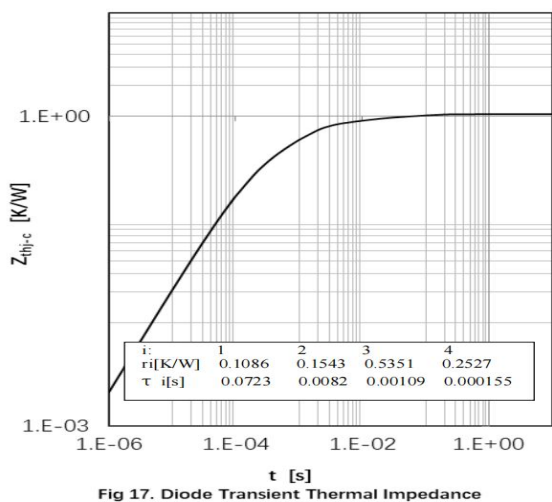
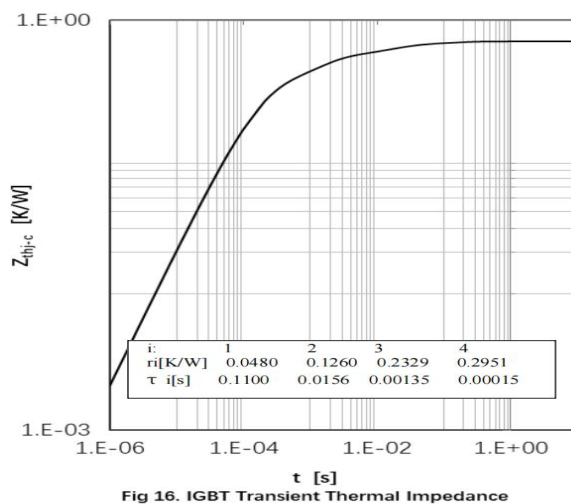
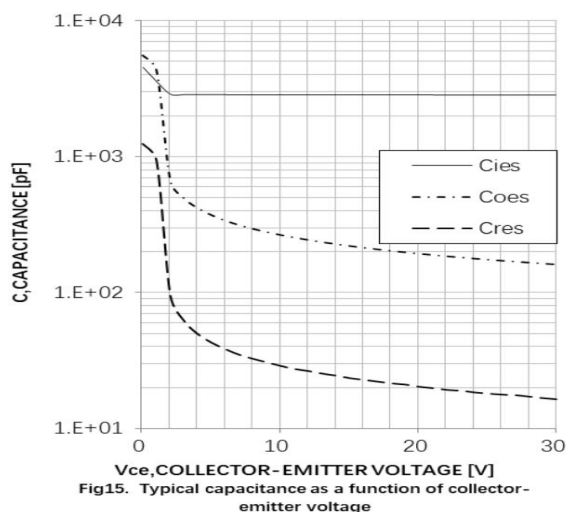
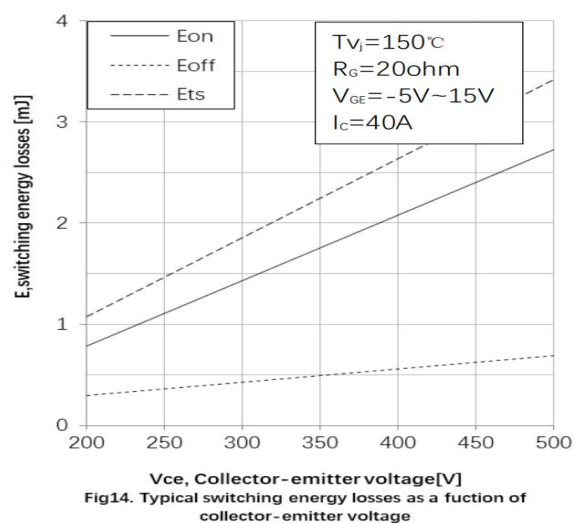
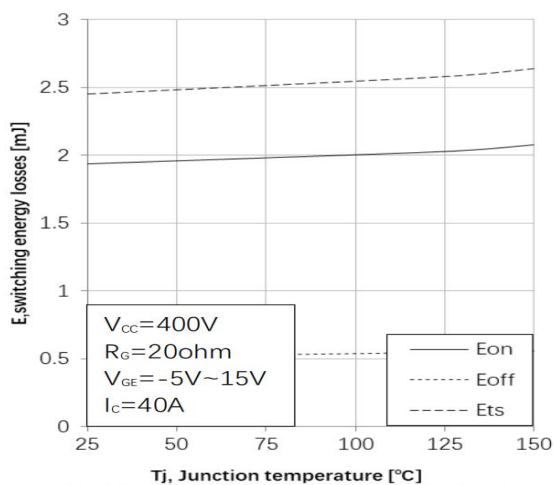
Typical Characteristics



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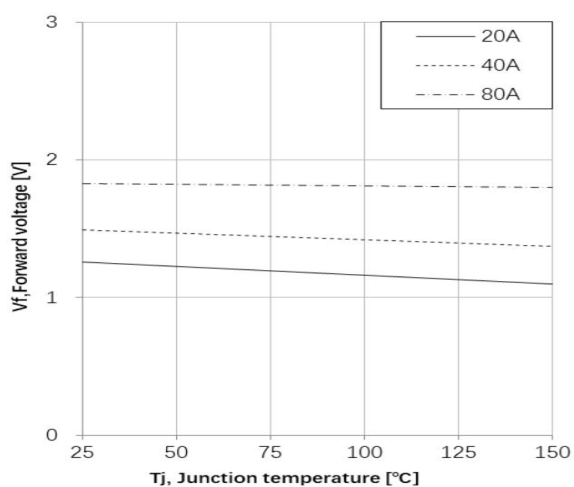
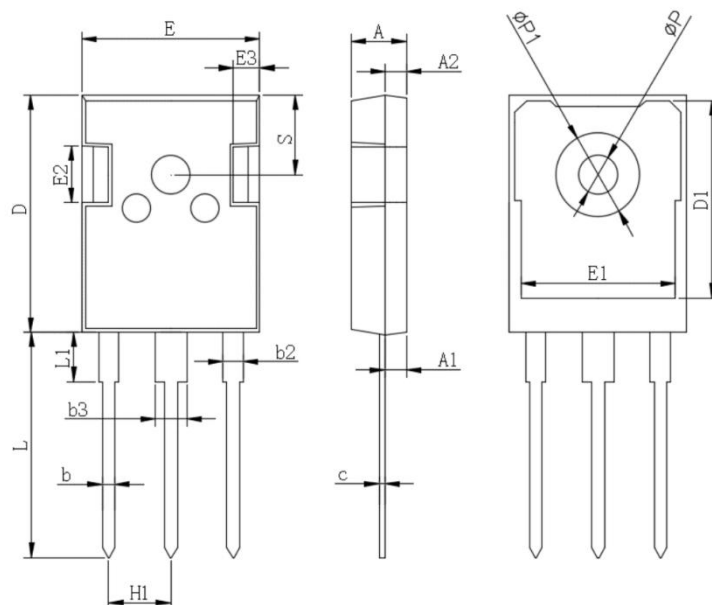


Fig19. Typical diode forward voltage as a function of Junction temperature

TO-247AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.800	5.200	0.189	0.205
A1	2.210	2.610	0.087	0.103
A2	1.850	2.150	0.073	0.085
b	1.000	1.400	0.039	0.055
b2	1.910	2.210	0.075	0.087
b3	2.800	3.200	0.110	0.126
C	0.500	0.700	0.020	0.028
D	20.700	21.300	0.815	0.839
D1	16.250	16.850	0.640	0.663
E	15.500	16.100	0.610	0.634
E1	13.000	13.600	0.512	0.535
E2	4.800	5.200	0.189	0.205
E3	2.300	2.700	0.091	0.106
L	19.620	20.220	0.772	0.796
L1	-	4.300	-	0.169
Φ P	3.400	3.800	0.134	0.150
Φ P1	-	7.300	-	0.287
S	6.150 TYP		0.242 TYP	
H1	5.440 TYP		0.214 TYP	